# 74LVC2T45; 74LVCH2T45

Dual supply translating transceiver; 3-state

Rev. 8 — 29 March 2013

**Product data sheet** 

#### **General description** 1.

The 74LVC2T45; 74LVCH2T45 are dual bit, dual supply translating transceivers with 3-state outputs that enable bidirectional level translation. They feature two 2-bits input-output ports (nA and nB), a direction control input (DIR) and dual supply pins (V<sub>CC(A)</sub> and  $V_{CC(B)}$ ). Both  $V_{CC(A)}$  and  $V_{CC(B)}$  can be supplied at any voltage between 1.2 V and 5.5 V making the device suitable for translating between any of the low voltage nodes (1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V and 5.0 V). Pins nA and DIR are referenced to V<sub>CC(A)</sub> and pins nB are referenced to V<sub>CC(B)</sub>. A HIGH on DIR allows transmission from nA to nB and a LOW on DIR allows transmission from nB to nA.

The devices are fully specified for partial power-down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either  $V_{CC(A)}$  or  $V_{CC(B)}$  are at GND level, both A port and B port are in the high-impedance OFF-state.

Active bus hold circuitry in the 74LVCH2T45 holds unused or floating data inputs at a valid logic level.

#### Features and benefits 2.

- Wide supply voltage range:
  - ◆ V<sub>CC(A)</sub>: 1.2 V to 5.5 V
  - ◆ V<sub>CC(B)</sub>: 1.2 V to 5.5 V
- High noise immunity
- Complies with JEDEC standards:
  - ◆ JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8C (2.7 V to 3.6 V)
  - ◆ JESD36 (4.5 V to 5.5 V)
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 4000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Maximum data rates:
  - ◆ 420 Mbps (3.3 V to 5.0 V translation)
  - 210 Mbps (translate to 3.3 V))
  - 140 Mbps (translate to 2.5 V)
  - 75 Mbps (translate to 1.8 V)
  - 60 Mbps (translate to 1.5 V)



- Suspend mode
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- $\pm$ 24 mA output drive (V<sub>CC</sub> = 3.0 V)
- Inputs accept voltages up to 5.5 V
- Low power consumption: 16 μA maximum I<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

## 3. Ordering information

Table 1. Ordering information

Type number	Package	Package								
	Temperature range	Name	Description	Version						
74LVC2T45DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads;	SOT765-1						
74LVCH2T45DC			body width 2.3 mm							
74LVC2T45GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads;	SOT833-1						
74LVCH2T45GT			8 terminals; body 1 $\times$ 1.95 $\times$ 0.5 mm							
74LVC2T45GF	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads;	SOT1089						
74LVCH2T45GF			8 terminals; body $1.35 \times 1 \times 0.5$ mm							
74LVC2T45GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads;	SOT996-2						
74LVCH2T45GD			8 terminals; body $3 \times 2 \times 0.5$ mm							
74LVC2T45GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads;	SOT902-2						
74LVCH2T45GM			8 terminals; body $1.6 \times 1.6 \times 0.5$ mm							
74LVC2T45GN	$-40~^{\circ}\text{C}$ to +125 $^{\circ}\text{C}$	XSON8 extremely thin small outline package; no leads;		SOT1116						
74LVCH2T45GN			8 terminals; body $1.2 \times 1.0 \times 0.35$ mm							
74LVC2T45GS	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads;	SOT1203						
74LVCH2T45GS			8 terminals; body $1.35 \times 1.0 \times 0.35$ mm							

## 4. Marking

Table 2. Marking

Type number	Marking code <sup>[1]</sup>
74LVC2T45DC	V45
74LVCH2T45DC	X45
74LVC2T45GT	V45
74LVCH2T45GT	X45
74LVC2T45GF	V5
74LVCH2T45GF	X5
74LVC2T45GD	V45
74LVCH2T45GD	X45
74LVC2T45GM	V45
74LVCH2T45GM	X45

74LVC\_LVCH2T45

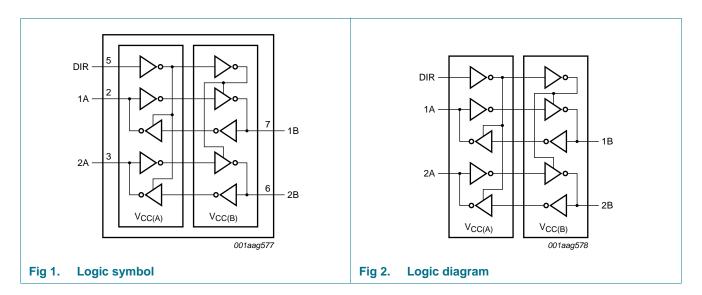
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 Table 2.
 Marking ...continued

Type number	Marking code <sup>[1]</sup>
74LVC2T45GN	V5
74LVCH2T45GN	X5
74LVC2T45GS	V5
74LVCH2T45GS	X5

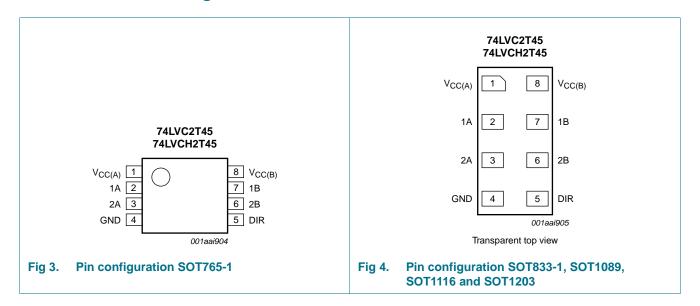
<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

## 5. Functional diagram



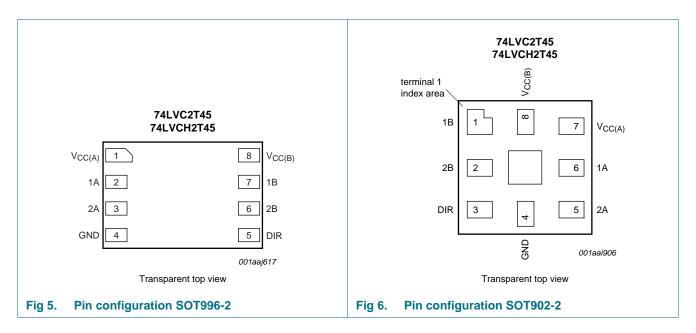
## 6. Pinning information

### 6.1 Pinning



74LVC\_LVCH2T45

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#### 6.2 Pin description

Table 3. Pin description

Symbol	Pin		Description
	SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203	SOT902-2	
$V_{CC(A)}$	1	7	supply voltage A (port A and DIR)
1A	2	6	data input or output
2A	3	5	data input or output
GND	4	4	ground (0 V)
DIR	5	3	direction control
2B	6	2	data input or output
1B	7	1	data input or output
$V_{CC(B)}$	8	8	supply voltage B (port B)

## 7. Functional description

Table 4. Function table[1]

Supply voltage	Input	Input/output[2]			
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	DIR	nA	nB		
1.2 V to 5.5 V	L	nA = nB	input		
1.2 V to 5.5 V	Н	input	nB = nA		
GND[3]	X	Z	Z		

- [1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.
- [2] The input circuit of the data I/O is always active.
- [3] When either  $V_{CC(A)}$  or  $V_{CC(B)}$  is at GND level, the device goes into suspend mode.

74LVC\_LVCH2T45

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

		<b>5</b> , (	0	10	,
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC(A)}$	supply voltage A		-0.5	+6.5	V
$V_{CC(B)}$	supply voltage B		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	<b>–50</b>	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	<b>–50</b>	-	mA
Vo	output voltage	Active mode	<u>[1][2][3]</u> –0.5	$V_{CCO} + 0.5$	V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CCO}$	[2] _	±50	mA
I <sub>CC</sub>	supply current	$I_{CC(A)}$ or $I_{CC(B)}$	-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	<u>[4]</u> _	250	mW

<sup>[1]</sup> The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC(A)}$	supply voltage A		1.2	5.5	V
V <sub>CC(B)</sub>	supply voltage B		1.2	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage	Active mode	<u>[1]</u> 0	$V_{CCO}$	V
		Suspend or 3-state mode	0	5.5	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V <sub>CCI</sub> = 1.2 V	<u>[2]</u> _	20	ns/V
		V <sub>CCI</sub> = 1.4 V to 1.95 V	-	20	ns/V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$	-	20	ns/V
		V <sub>CCI</sub> = 3 V to 3.6 V	-	10	ns/V
		V <sub>CCI</sub> = 4.5 V to 5.5 V	-	5	ns/V

<sup>[1]</sup>  $V_{CCO}$  is the supply voltage associated with the output port.

74LVC\_LVCH2T45

<sup>[2]</sup>  $V_{CCO}$  is the supply voltage associated with the output port.

<sup>[3]</sup>  $V_{CCO}$  + 0.5 V should not exceed 6.5 V.

<sup>[4]</sup> For VSSOP8 packages: above 110 °C the value of P<sub>tot</sub> derates linearly with 8.0 mW/K.
For XSON8 and XQFN8 packages: above 118 °C the value of P<sub>tot</sub> derates linearly with 7.8 mW/K.

<sup>[2]</sup>  $V_{CCI}$  is the supply voltage associated with the input port.

## 10. Static characteristics

Table 7. Typical static characteristics at T<sub>amb</sub> = 25 °C

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$					
		$I_0 = -3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	<u>[1]</u>	-	1.09	-	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$					
		$I_O = 3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	<u>[1]</u>	-	0.07	-	V
l <sub>l</sub>	input leakage current	DIR input; $V_I = 0 \text{ V to } 5.5 \text{ V}$ ; $V_{CCI} = 1.2 \text{ V to } 5.5 \text{ V}$	[2]	-	-	±1	μΑ
I <sub>BHL</sub>	bus hold LOW current	A or B port; $V_I = 0.42 \text{ V}$ ; $V_{CCI} = 1.2 \text{ V}$	[2]	-	19	-	μΑ
I <sub>BHH</sub>	bus hold HIGH current	A or B port; $V_I = 0.78 \text{ V}$ ; $V_{CCI} = 1.2 \text{ V}$	[2]	-	-19	-	μΑ
I <sub>BHLO</sub>	bus hold LOW overdrive current	A or B port; $V_{CCI} = 1.2 \text{ V}$	[2][3]	-	19	-	μΑ
I <sub>BHHO</sub>	bus hold HIGH overdrive current	A or B port; $V_{CCI} = 1.2 \text{ V}$	[2][3]	-	-19	-	μА
l <sub>OZ</sub>	OFF-state output current	A or B port; $V_O = 0 \text{ V or } V_{CCO}$ ; $V_{CCO} = 1.2 \text{ V to } 5.5 \text{ V}$	<u>[1]</u>	-	-	±1	μΑ
I <sub>OFF</sub>	power-off leakage current	A port; $V_1$ or $V_0 = 0$ V to 5.5 V; $V_{CC(A)} = 0$ V; $V_{CC(B)} = 1.2$ V to 5.5 V		-	-	±1	μΑ
		B port; $V_1$ or $V_0 = 0$ V to 5.5 V; $V_{CC(B)} = 0$ V; $V_{CC(A)} = 1.2$ V to 5.5 V		-	-	±1	μΑ
C <sub>I</sub>	input capacitance	DIR input; $V_1 = 0 \text{ V or } 3.3 \text{ V};$ $V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$		-	2.2	-	pF
C <sub>I/O</sub>	input/output capacitance	A and B port; suspend mode; $V_O = 3.3 \text{ V or } 0 \text{ V; } V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$		-	6.0	-	pF

<sup>[1]</sup>  $V_{CCO}$  is the supply voltage associated with the output port.

<sup>[2]</sup> V<sub>CCI</sub> is the supply voltage associated with the data input port.

<sup>[3]</sup> To guarantee the node switches, an external driver must source/sink at least IBHLO/IBHHO when the input is in the range VIL to VIH.

Table 8. Static characteristics

Symbol	Parameter	Conditions	-40 °C 1	to +85 °C	-40 °C to	+125 °C	Unit
			Min	Max	Min	Max	
$V_{IH}$	HIGH-level	data input	<u>[1]</u>				
	input voltage	V <sub>CCI</sub> = 1.2 V	0.8V <sub>CCI</sub>	-	0.8V <sub>CCI</sub>	-	V
		V <sub>CCI</sub> = 1.4 V to 1.95 V	0.65V <sub>CCI</sub>	-	$0.65V_{CCI}$	-	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	1.7	-	V
		$V_{CCI} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	2.0	-	V
		V <sub>CCI</sub> = 4.5 V to 5.5 V	0.7V <sub>CCI</sub>	-	0.7V <sub>CCI</sub>	-	V
		DIR input					
		V <sub>CCI</sub> = 1.2 V	0.8V <sub>CC(A)</sub>	-	0.8V <sub>CC(A)</sub>	-	V
		V <sub>CCI</sub> = 1.4 V to 1.95 V	0.65V <sub>CC(A)</sub>	-	0.65V <sub>CC(A)</sub>	-	V
		V <sub>CCI</sub> = 2.3 V to 2.7 V	1.7	-	1.7	-	V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	2.0	-	2.0	-	V
		V <sub>CCI</sub> = 4.5 V to 5.5 V	0.7V <sub>CC(A)</sub>	-	0.7V <sub>CC(A)</sub>	-	V
$V_{IL}$	LOW-level	data input	<u>[1]</u>				
	input voltage	V <sub>CCI</sub> = 1.2 V	-	0.2V <sub>CCI</sub>	-	0.2V <sub>CCI</sub>	V
		V <sub>CCI</sub> = 1.4 V to 1.95 V	-	0.35V <sub>CCI</sub>	-	0.35V <sub>CCI</sub>	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$	-	0.7	-	0.7	V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	-	0.8	-	0.8	V
		V <sub>CCI</sub> = 4.5 V to 5.5 V	-	0.3V <sub>CCI</sub>	-	0.3V <sub>CCI</sub>	V
		DIR input					
		V <sub>CCI</sub> = 1.2 V	-	0.2V <sub>CC(A)</sub>	-	0.2V <sub>CC(A)</sub>	V
		V <sub>CCI</sub> = 1.4 V to 1.95 V	-	0.35V <sub>CC(A)</sub>	-	0.35V <sub>CC(A)</sub>	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$	-	0.7	-	0.7	V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	-	0.8	-	0.8	V
		V <sub>CCI</sub> = 4.5 V to 5.5 V	-	0.3V <sub>CC(A)</sub>	-	0.3V <sub>CC(A)</sub>	V
$V_{OH}$	HIGH-level	$V_{I} = V_{IH}$					
	output voltage	$I_O = -100 \mu A;$ $V_{CCO} = 1.2 \text{ V to } 4.5 \text{ V}$	[2] V <sub>CCO</sub> – 0.1	-	V <sub>CCO</sub> – 0.1	-	V
		$I_{O} = -6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$	1.0	-	1.0	-	V
		$I_{O} = -8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$	1.2	-	1.2	-	V
		$I_{O} = -12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$	1.9	-	1.9	-	V
		$I_{O} = -24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$	2.4	-	2.4	-	V
		$I_{O} = -32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$	3.8	-	3.8	-	V

 Table 8.
 Static characteristics ...continued

Symbol	Parameter	Conditions		-40 °C t	o +85 °C	-40 °C to	-40 °C to +125 °C	
				Min	Max	Min	Max	
$V_{OL}$	LOW-level	$V_I = V_{IL}$	<u>[2]</u>			1		
	output voltage	$I_O = 100 \mu A;$ $V_{CCO} = 1.2 \text{ V to } 4.5 \text{ V}$		-	0.1	-	0.1	V
		$I_O = 6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		-	0.3	-	0.3	V
		$I_O = 8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		-	0.45	-	0.45	V
		$I_O = 12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		-	0.3	-	0.3	V
		$I_O = 24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		-	0.55	-	0.55	V
		$I_O = 32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		-	0.55	-	0.55	V
I <sub>I</sub>	input leakage current	DIR input; $V_I = 0 \text{ V to } 5.5 \text{ V}$ ; $V_{CCI} = 1.2 \text{ V to } 5.5 \text{ V}$		-	±2	-	±10	μΑ
I <sub>BHL</sub>	bus hold LOW	A or B port	<u>[1]</u>					
	current	V <sub>I</sub> = 0.49 V; V <sub>CCI</sub> = 1.4 V		15	-	10	-	μΑ
		V <sub>I</sub> = 0.58 V; V <sub>CCI</sub> = 1.65 V		25	-	20	-	μΑ
		V <sub>I</sub> = 0.70 V; V <sub>CCI</sub> = 2.3 V		45	-	45	-	μΑ
		V <sub>I</sub> = 0.80 V; V <sub>CCI</sub> = 3.0 V		100	-	80	-	μΑ
		V <sub>I</sub> = 1.35 V; V <sub>CCI</sub> = 4.5 V		100	-	100	-	μΑ
I <sub>BHH</sub>	bus hold HIGH current	A or B port	<u>[1]</u>					
		V <sub>I</sub> = 0.91 V; V <sub>CCI</sub> = 1.4 V		-15	-	-10	-	μΑ
		V <sub>I</sub> = 1.07 V; V <sub>CCI</sub> = 1.65 V		-25	-	-20	-	μΑ
		V <sub>I</sub> = 1.60 V; V <sub>CCI</sub> = 2.3 V		-45	-	-45	-	μΑ
		$V_{I} = 2.00 \text{ V}; V_{CCI} = 3.0 \text{ V}$		-100	-	-80	-	μΑ
		$V_I = 3.15 \text{ V}; V_{CCI} = 4.5 \text{ V}$		-100	-	-100	-	μΑ
I <sub>BHLO</sub>	bus hold LOW	A or B port	[1][3]					
	overdrive current	V <sub>CCI</sub> = 1.6 V		125	-	125	-	μΑ
	Current	V <sub>CCI</sub> = 1.95 V		200	-	200	-	μΑ
		$V_{CCI} = 2.7 V$		300	-	300	-	μΑ
		V <sub>CCI</sub> = 3.6 V		500	-	500	-	μΑ
		$V_{CCI} = 5.5 V$		900	-	900	-	μΑ
I <sub>BHHO</sub>	bus hold HIGH	A or B port	[1][3]					
	overdrive current	V <sub>CCI</sub> = 1.6 V		-125	-	-125	-	μΑ
	Julient	V <sub>CCI</sub> = 1.95 V		-200	-	-200	-	μΑ
		$V_{CCI} = 2.7 V$		-300	-	-300	-	μΑ
		V <sub>CCI</sub> = 3.6 V		-500	-	-500	-	μΑ
		V <sub>CCI</sub> = 5.5 V		-900	-	-900	-	μΑ
l <sub>OZ</sub>	OFF-state output current	A or B port; $V_O = 0 \text{ V or } V_{CCO}$ ; $V_{CCO} = 1.2 \text{ V to } 5.5 \text{ V}$	[2]	-	±2	-	±10	μΑ

 Table 8.
 Static characteristics ...continued

Symbol	Parameter	Conditions		-40 °C 1	to +85 °C	-40 °C to	Unit	
				Min	Max	Min	Max	
l <sub>OFF</sub>	power-off leakage current	A port; $V_1$ or $V_0 = 0$ V to 5.5 V; $V_{CC(A)} = 0$ V; $V_{CC(B)} = 1.2$ V to 5.5 V		-	±2	-	±10	μА
		B port; $V_I$ or $V_O = 0$ V to 5.5 V; $V_{CC(B)} = 0$ V; $V_{CC(A)} = 1.2$ V to 5.5 V		-	±2	-	±10	μА
I <sub>CC</sub>	supply current	A port; $V_I = 0 \text{ V or } V_{CCI}$ ; $I_O = 0 \text{ A}$	[1]					
		$V_{CC(A)}$ , $V_{CC(B)} = 1.2 \text{ V to } 5.5 \text{ V}$		-	8	-	8	μΑ
		$V_{CC(A)}$ , $V_{CC(B)} = 1.65 \text{ V}$ to 5.5 V		-	3	-	3	μΑ
		$V_{CC(A)} = 5.5 \text{ V}; V_{CC(B)} = 0 \text{ V}$		-	2	-	2	μΑ
		$V_{CC(A)} = 0 \text{ V}; V_{CC(B)} = 5.5 \text{ V}$		-2	-	-2	-	μΑ
		B port; $V_I = 0 \text{ V or } V_{CCI}$ ; $I_O = 0 \text{ A}$						
		$V_{CC(A)}$ , $V_{CC(B)} = 1.2 \text{ V to } 5.5 \text{ V}$		-	8	-	8	μΑ
		$V_{CC(A)}$ , $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$		-	3	-	3	μΑ
		$V_{CC(B)} = 0 \text{ V}; V_{CC(A)} = 5.5 \text{ V}$		-2	-	-2	-	μΑ
		$V_{CC(B)} = 5.5 \text{ V}; V_{CC(A)} = 0 \text{ V}$		-	2	-	2	μΑ
		A plus B port $(I_{CC(A)} + I_{CC(B)})$ ; $I_O = 0$ A; $V_I = 0$ V or $V_{CCI}$						
		$V_{CC(A)}$ , $V_{CC(B)} = 1.2 \text{ V to } 5.5 \text{ V}$		-	16	-	16	μΑ
		$V_{CC(A)}$ , $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$		-	4	-	4	μΑ
$\Delta I_{CC}$	additional supply current	per input; $V_{CC(A)}$ , $V_{CC(B)} = 3.0 \text{ V}$ to 5.5 V						
		A port; A port at $V_{CC(A)} - 0.6 \text{ V}$ ; DIR at $V_{CC(A)}$ ; B port = open	<u>[4]</u>	-	50	-	75	μΑ
		DIR input; DIR at $V_{CC(A)} - 0.6 \text{ V}$ ; A port at $V_{CC(A)}$ or GND; B port = open		-	50	-	75	μА
		B port; B port at $V_{CC(B)} - 0.6 \text{ V}$ ; DIR at GND; A port = open	<u>[4]</u>	-	50	-	75	μА

<sup>[1]</sup>  $V_{CCI}$  is the supply voltage associated with the data input port.

<sup>[2]</sup>  $V_{\text{CCO}}$  is the supply voltage associated with the output port.

<sup>[3]</sup> To guarantee the node switches, an external driver must source/sink at least  $I_{BHLO}/I_{BHHO}$  when the input is in the range  $V_{IL}$  to  $V_{IH}$ .

<sup>[4]</sup> For non bus hold parts only (74LVC2T45).

## 11. Dynamic characteristics

Table 9. Typical dynamic characteristics at  $V_{CC(A)} = 1.2 \text{ V}$  and  $T_{amb} = 25 \text{ °C}$ Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>; for waveforms see <u>Figure 7</u> and <u>Figure 8</u>.

Symbol	Parameter	Conditions		V <sub>CC(B)</sub>						
				1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t <sub>PLH</sub>	LOW to HIGH	A to B	·	10.6	8.1	7.0	5.8	5.3	5.1	ns
	propagation delay	B to A		10.6	9.5	9.0	8.5	8.3	8.2	ns
t <sub>PHL</sub>	HIGH to LOW	A to B		10.1	7.1	6.0	5.3	5.2	5.4	ns
	propagation delay	B to A		10.1	8.6	8.1	7.8	7.6	7.6	ns
t <sub>PHZ</sub>	HIGH to OFF-state	DIR to A		9.4	9.4	9.4	9.4	9.4	9.4	ns
	propagation delay	DIR to B		12.0	9.4	9.0	7.8	8.4	7.9	ns
t <sub>PLZ</sub>	LOW to OFF-state	DIR to A		7.1	7.1	7.1	7.1	7.1	7.1	ns
	propagation delay	DIR to B		9.5	7.8	7.7	6.9	7.6	7.0	ns
t <sub>PZH</sub>	OFF-state to HIGH	DIR to A	<u>[1]</u>	20.1	17.3	16.7	15.4	15.9	15.2	ns
	propagation delay	DIR to B	<u>[1]</u>	17.7	15.2	14.1	12.9	12.4	12.2	ns
t <sub>PZL</sub>	OFF-state to LOW	DIR to A	[1]	22.1	18.0	17.1	15.6	16.0	15.5	ns
	propagation delay	DIR to B	[1]	19.5	16.5	15.4	14.7	14.6	14.8	ns

<sup>[1]</sup> t<sub>PZH</sub> and t<sub>PZL</sub> are calculated values using the formula shown in Section 14.4 "Enable times".

Table 10. Typical dynamic characteristics at  $V_{CC(B)} = 1.2 \text{ V}$  and  $T_{amb} = 25 \text{ °C}$ Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>; for waveforms see <u>Figure 7</u> and <u>Figure 8</u>.

Symbol	Parameter	Conditions				Vc	C(A)			Unit
				1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t <sub>PLH</sub>	LOW to HIGH	A to B	'	10.6	9.5	9.0	8.5	8.3	8.2	ns
	propagation delay	B to A		10.6	8.1	7.0	5.8	5.3	5.1	ns
t <sub>PHL</sub>	HIGH to LOW	A to B		10.1	8.6	8.1	7.8	7.6	7.6	ns
	propagation delay	B to A		10.1	7.1	6.0	5.3	5.2	5.4	ns
t <sub>PHZ</sub>	HIGH to OFF-state	DIR to A		9.4	6.5	5.7	4.1	4.1	3.0	ns
	propagation delay	DIR to B		12.0	6.1	5.4	4.6	4.3	4.0	ns
t <sub>PLZ</sub>	LOW to OFF-state	DIR to A		7.1	4.9	4.5	3.2	3.4	2.5	ns
	propagation delay	DIR to B		9.5	7.3	6.6	5.9	5.7	5.6	ns
t <sub>PZH</sub>	OFF-state to HIGH	DIR to A	<u>[1]</u>	20.1	15.4	13.6	11.7	11.0	10.7	ns
	propagation delay	DIR to B	<u>[1]</u>	17.7	14.4	13.5	11.7	11.7	10.7	ns
t <sub>PZL</sub>	OFF-state to LOW	DIR to A	<u>[1]</u>	22.1	13.2	11.4	9.9	9.5	9.4	ns
	aranagation dalay	DIR to B	[1]	19.5	15.1	13.8	11.9	11.7	10.6	ns

<sup>[1]</sup>  $t_{PZH}$  and  $t_{PZL}$  are calculated values using the formula shown in <u>Section 14.4 "Enable times"</u>.

Table 11. Typical power dissipation capacitance at  $V_{CC(A)} = V_{CC(B)}$  and  $T_{amb} = 25 \, ^{\circ}C \, \frac{[1][2]}{C}$ 

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		V <sub>CC(A)</sub> ar	nd V <sub>CC(B)</sub>		Unit
			1.8 V	2.5 V	3.3 V	5.0 V	
$C_{PD}$	power dissipation capacitance	A port: (direction A to B); B port: (direction B to A)	2	3	3	4	pF
		A port: (direction B to A); B port: (direction A to B)	15	16	16	18	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

[2]  $f_i = 10$  MHz;  $V_I = GND$  to  $V_{CC}$ ;  $t_f = t_f = 1$  ns;  $C_L = 0$  pF;  $R_L = \infty \Omega$ .

Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

Symbol	Parameter	Conditions					Vcc	(B)					Unit
			1.5 V :	± 0.1 V	1.8 V ±	0.15 V	2.5 V :		3.3 V	± 0.3 V	5.0 V	± 0.5 V	Ī
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>CC(A)</sub> =	1.4 V to 1.6 V								•			•	
t <sub>PLH</sub>	LOW to HIGH	A to B	2.8	21.3	2.4	17.6	2.0	13.5	1.7	11.8	1.6	10.5	ns
	propagation delay	B to A	2.8	21.3	2.6	19.1	2.3	14.9	2.3	12.4	2.2	12.0	ns
t <sub>PHL</sub>	HIGH to LOW	A to B	2.6	19.3	2.2	15.3	1.8	11.8	1.7	10.9	1.7	10.8	ns
	propagation delay	B to A	2.6	19.3	2.4	17.3	2.3	13.2	2.2	11.3	2.3	11.0	ns
t <sub>PHZ</sub>	propagation delay	DIR to A	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	ns
		DIR to B	3.5	24.8	3.5	23.6	3.0	11.0	3.3	11.3	2.8	10.3	ns
$t_{PLZ}$		DIR to A	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	ns
		DIR to B	2.8	18.3	3.0	17.2	2.5	9.4	3.0	10.1	2.5	9.4	ns
t <sub>PZH</sub>	OFF-state to HIGH	DIR to A [1]	-	39.6	-	36.3	-	24.3	-	22.5	-	21.4	ns
	propagation delay	DIR to B [1]	-	32.7	-	29.0	-	24.9	-	23.2	-	21.9	ns
t <sub>PZL</sub>	OFF-state to LOW	DIR to A [1]	-	44.1	-	40.9	-	24.2	-	22.6	-	21.3	ns
	propagation delay	DIR to B [1]	-	38.0	-	34.0	-	30.5	-	29.6	-	29.5	ns
V <sub>CC(A)</sub> =	1.65 V to 1.95 V												
t <sub>PLH</sub>	LOW to HIGH	A to B	2.6	19.1	2.2	17.7	2.2	9.3	1.7	7.2	1.4	6.8	ns
	propagation delay	B to A	2.4	17.6	2.2	17.7	2.3	16.0	2.1	15.5	1.9	15.1	ns
t <sub>PHL</sub>	HIGH to LOW	A to B	2.4	17.3	2.0	14.3	1.6	8.5	1.8	7.1	1.7	7.0	ns
	propagation delay	B to A	2.2	15.3	2.0	14.3	2.1	12.9	2.0	12.6	1.8	12.2	ns
t <sub>PHZ</sub>	HIGH to OFF-state	DIR to A	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	ns
	propagation delay	DIR to B	3.2	24.1	3.2	21.9	2.7	11.5	3.0	10.3	2.5	8.2	ns
t <sub>PLZ</sub>	LOW to OFF-state	DIR to A	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	ns
	propagation delay	DIR to B	2.5	17.6	2.6	16.0	2.2	9.2	2.7	8.4	2.4	7.1	ns

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Table 12. Dynamic characteristics for temperature range –40 °C to +85 °C ...continued Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

$ \begin{array}{ c c c c c c c c } \hline & & & & & & & & & & & & & & & & & & $	Min Max 2 - 23.9 3 - 17.7 4 - 22.9 5 - 24.2 1.3 6.2 1.4 8.0 1.3 5.4	Min	Max 22.2 n 17.3 n 20.4 n 24.1 n 4.8 n 7.5 n	ns ns ns
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	2 - 23.9 3 - 17.7 4 - 22.9 5 - 24.2 1.3 6.2 1.4 8.0 1.3 5.4	)	22.2 n 17.3 n 20.4 n 24.1 n 4.8 n 7.5 n	ns ns ns
propagation delay         DIR to B         11         -         29.6         -         28.2         -         19.8           tPZL         OFF-state to LOW propagation delay         DIR to A         11         -         39.4         -         36.2         -         24.4           DIR to B         11         -         34.4         -         31.4         -         25.6           VCC(A) = 2.3 V to 2.7 V         V         V         V         V         V         -         31.4         -         25.6           tPLH         LOW to HIGH propagation delay         A to B         2.3         17.9         2.3         16.0         1.5         8.5           tPHL         HIGH to LOW         A to B         2.3         15.8         2.1         12.9         1.4         7.5	3 - 17.7 4 - 22.9 5 - 24.2 1.3 6.2 1.4 8.0 1.3 5.4	7	17.3 n 20.4 n 24.1 n 4.8 n 7.5 n	ns ns ns
t <sub>PZL</sub> OFF-state to LOW propagation delay DIR to A 11 - 39.4 - 36.2 - 24.4    V <sub>CC(A)</sub> = 2.3 V to 2.7 V    t <sub>PLH</sub> LOW to HIGH propagation delay Propagation delay Propagation delay B to A 2.0 13.5 2.2 9.3 1.5 8.5    t <sub>PHL</sub> HIGH to LOW A to B 2.3 15.8 2.1 12.9 1.4 7.5	1.3 6.2 1.4 8.0 1.3 5.4	1.1	20.4 n 24.1 n 4.8 n 7.5 n	ns ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	1.3 6.2 1.4 8.0 1.3 5.4	1.1	24.1 n 4.8 n 7.5 n	าร
V <sub>CC(A)</sub> = 2.3 V to 2.7 V         t <sub>PLH</sub> LOW to HIGH propagation delay       A to B       2.3       17.9       2.3       16.0       1.5       8.5         t <sub>PHL</sub> HIGH to LOW       A to B       2.3       15.8       2.1       12.9       1.4       7.5	1.3 6.2 1.4 8.0 1.3 5.4	1.1 1.0	4.8 n 7.5 n	าร
t <sub>PLH</sub> LOW to HIGH A to B 2.3 17.9 2.3 16.0 1.5 8.5 propagation delay B to A 2.0 13.5 2.2 9.3 1.5 8.5 t <sub>PHL</sub> HIGH to LOW A to B 2.3 15.8 2.1 12.9 1.4 7.5	1.4 8.0 1.3 5.4	1.0	7.5 n	
propagation delay B to A 2.0 13.5 2.2 9.3 1.5 8.5 t <sub>PHL</sub> HIGH to LOW A to B 2.3 15.8 2.1 12.9 1.4 7.5	1.4 8.0 1.3 5.4	1.0	7.5 n	
t <sub>PHL</sub> HIGH to LOW A to B 2.3 15.8 2.1 12.9 1.4 7.5	1.3 5.4			٠.
near action delect		0.9		15
propagation delay B to A 1.8 11.8 1.9 8.5 1.4 7.5	1.3 7.0		4.6 n	าร
		0.9	6.2 n	าร
t <sub>PHZ</sub> HIGH to OFF-state DIR to A 2.1 8.1 2.1 8.1 2.1 8.1	2.1 8.1	2.1	8.1 n	าร
propagation delay DIR to B 3.0 22.5 3.0 21.4 2.5 11.0	2.8 9.3	2.3	6.9 n	าร
t <sub>PLZ</sub> LOW to OFF-state DIR to A 1.7 5.8 1.7 5.8 1.7 5.8	1.7 5.8	1.7	5.8 n	าร
propagation delay DIR to B 2.3 14.6 2.5 13.2 2.0 9.0	2.5 8.4	1.8	5.8 n	าร
t <sub>PZH</sub> OFF-state to HIGH DIR to A 11 - 28.1 - 22.5 - 17.5	5 - 16.4	1 -	13.3 n	าร
propagation delay DIR to B 11 - 23.7 - 21.8 - 14.3	3 - 12.0	) -	10.6 n	าร
t <sub>PZL</sub> OFF-state to LOW DIR to A [1] - 34.3 - 29.9 - 18.5	5 - 16.0	3 -	13.1 n	าร
propagation delay DIR to B 11 - 23.9 - 21.0 - 15.6	6 - 13.5	5 -	12.7 n	าร
$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$				
$t_{PLH}$ LOW to HIGH A to B 2.3 17.1 2.1 15.5 1.4 8.0	0.8 5.6	0.7	4.4 n	าร
propagation delay B to A 1.7 11.8 1.7 7.2 1.3 6.2	0.7 5.6	0.6	5.4 n	าร
$t_{PHL}$ HIGH to LOW A to B 2.2 15.6 2.0 12.6 1.3 7.0	0.8 5.0	0.7	4.0 n	าร
propagation delay B to A 1.7 10.9 1.8 7.1 1.3 5.4	0.8 5.0	0.7	4.5 n	าร
$t_{\text{PHZ}}$ HIGH to OFF-state DIR to A 2.3 7.3 2.3 7.3 2.3 7.3	2.3 7.3	2.7	7.3 n	าร
propagation delay DIR to B 2.9 18.0 2.9 16.5 2.3 10.1	1 2.7 8.6	2.2	6.3 n	าร
$t_{\text{PLZ}}$ LOW to OFF-state DIR to A 2.0 5.6 2.0 5.6 2.0 5.6	2.0 5.6	2.0	5.6 n	าร
propagation delay DIR to B 2.3 13.6 2.4 12.5 1.9 7.8	2.3 7.1	1.7	4.9 n	าร
t <sub>PZH</sub> OFF-state to HIGH DIR to A [1] - 25.4 - 19.7 - 14.0	) - 12.7	7 -	10.3 n	าร
propagation delay DIR to B 🔟 - 22.7 - 21.1 - 13.6	6 - 11.2	2 -	10.0 n	าร
t <sub>PZL</sub> OFF-state to LOW DIR to A [1] - 28.9 - 23.6 - 15.5	5 - 13.6	6 -	10.8 n	าร
propagation delay DIR to B [1] - 22.9 - 19.9 - 14.3	3 - 12.0	3 -	11.3 n	าร
V <sub>CC(A)</sub> = 4.5 V to 5.5 V				
t <sub>PLH</sub> LOW to HIGH A to B 2.2 16.6 1.9 15.1 1.0 7.5	0.7 5.4	0.5	3.9 n	าร
propagation delay B to A 1.6 10.5 1.4 6.8 1.0 4.8	0.7 4.4	0.5	3.9 n	าร
t <sub>PHL</sub> HIGH to LOW A to B 2.3 15.3 1.8 12.2 1.0 6.2	0.7 4.5	0.5	3.5 n	าร
propagation delay B to A 1.7 10.8 1.7 7.0 0.9 4.6	0.7 4.0	0.5	3.5 n	าร
t <sub>PHZ</sub> HIGH to OFF-state DIR to A 1.7 5.4 1.7 5.4 1.7 5.4	1.7 5.4	1.7	5.4 n	าร
propagation delay DIR to B 2.9 17.3 2.9 16.1 2.3 9.7	2.7 8.0	2.5	5.7 n	าร

12 of 36

Table 12. Dynamic characteristics for temperature range –40 °C to +85 °C ...continued Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>; for wave forms see <u>Figure 7</u> and <u>Figure 8</u>.

Symbol	Parameter	Conditions					Vcc	(B)					Unit	
			1.5 V ±	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	Ŀ 0.2 V	3.3 V =	Ŀ 0.3 V	5.0 V ±	Ŀ 0.5 V		
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
$t_{PLZ}$	LOW to OFF-state	DIR to A	1.4	3.7	1.4	3.7	1.3	3.7	1.0	3.7	0.9	3.7	ns	
	propagation delay	DIR to B	2.3	13.1	2.4	12.1	1.9	7.4	2.3	7.0	1.8	4.5	ns	
t <sub>PZH</sub>	OFF-state to HIGH	DIR to A [1]	-	23.6	-	18.9	-	12.2	-	11.4	-	8.4	ns	
	propagation delay	propagation delay	DIR to B [1]	-	20.3	-	18.8	-	11.2	-	9.1	-	7.6	ns
t <sub>PZL</sub>	propagation dolay	DIR to A [1]	-	28.1	-	23.1	-	14.3	-	12.0	-	9.2	ns	
		DIR to B [1]	-	20.7	-	17.6	-	11.6	-	9.9	-	8.9	ns	

<sup>[1]</sup> t<sub>PZH</sub> and t<sub>PZL</sub> are calculated values using the formula shown in <u>Section 14.4 "Enable times"</u>.

Table 13. Dynamic characteristics for temperature range –40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

Symbol	Parameter	Conditions					Vcc	(B)					Unit
			1.5 V ±	Ŀ 0.1 V	1.8 V ±	0.15 V	2.5 V :		3.3 V :	± 0.3 V	5.0 V ±	0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>CC(A)</sub> =	1.4 V to 1.6 V	1			1			'		'			
t <sub>PLH</sub>	LOW to HIGH	A to B	2.5	23.5	2.1	19.4	1.8	14.9	1.5	13.0	1.4	11.6	ns
	propagation delay	B to A	2.5	23.5	2.3	21.1	2.0	16.4	2.0	13.7	1.9	13.2	ns
t <sub>PHL</sub>	HIGH to LOW	A to B	2.3	21.3	1.9	16.9	1.6	13.0	1.5	12.0	1.5	11.9	ns
	propagation delay	B to A	2.3	21.3	2.1	19.1	2.0	14.6	1.9	12.5	2.0	12.1	ns
t <sub>PHZ</sub>	HIGH to OFF-state	DIR to A	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	ns
	propagation delay	DIR to B	3.1	27.3	3.1	26.0	2.7	12.1	2.9	12.5	2.5	11.4	ns
t <sub>PLZ</sub>	LOW to OFF-state propagation delay	DIR to A	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	ns
		DIR to B	2.5	20.2	2.7	19.0	2.2	10.4	2.7	11.2	2.2	10.4	ns
t <sub>PZH</sub>	OFF-state to HIGH	DIR to A [1]	-	43.7	-	40.1	-	26.8	-	24.9	-	23.6	ns
	propagation delay	DIR to B [1]	-	36.1	-	32.0	-	27.5	-	25.6	-	24.2	ns
t <sub>PZL</sub>	OFF-state to LOW	DIR to A [1]	-	48.6	-	45.1	-	26.7	-	25.0	-	23.5	ns
	propagation delay	DIR to B [1]	-	41.9	-	37.5	-	33.6	-	32.6	-	32.5	ns
V <sub>CC(A)</sub> =	1.65 V to 1.95 V												
t <sub>PLH</sub>	LOW to HIGH	A to B	2.3	21.1	1.9	19.5	1.9	10.3	1.5	8.0	1.2	7.5	ns
	propagation delay	B to A	2.1	19.4	1.9	19.5	2.0	17.6	1.8	17.1	1.7	16.7	ns
t <sub>PHL</sub>	HIGH to LOW	A to B	2.1	19.1	1.8	15.8	1.4	9.4	1.6	7.9	1.5	7.7	ns
	propagation delay	B to A	1.9	16.9	1.8	15.8	1.8	14.2	1.8	13.9	1.6	13.5	ns
t <sub>PHZ</sub>	HIGH to OFF-state	DIR to A	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	ns
	propagation delay	DIR to B	2.8	26.6	2.8	24.1	2.4	12.7	2.7	11.4	2.2	9.1	ns
$t_{PLZ}$	LOW to OFF-state	DIR to A	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	ns
	propagation delay	DIR to B	2.2	19.4	2.3	17.6	1.9	10.2	2.4	9.3	2.1	7.9	ns
t <sub>PZH</sub>	OFF-state to HIGH	DIR to A [1]	-	38.8	-	37.1	-	27.8	-	26.4	-	24.6	ns
	propagation doloy	DIR to B [1]	-	32.7	-	31.1	-	21.9	-	19.6	-	19.1	ns

Table 13. Dynamic characteristics for temperature range –40 °C to +125 °C ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 9</u>; for wave forms see <u>Figure 7</u> and <u>Figure 8</u>.

Symbol	Parameter	Conditions					Vcc	C(B)					Unit
			1.5 V	± 0.1 V	1.8 V ±	£ 0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V :	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>PZL</sub>	OFF-state to LOW	DIR to A [1]	-	43.5	-	39.9	-	26.9	-	25.3	-	22.6	ns
	propagation delay	DIR to B [1]	-	38.0	-	34.7	-	28.3	-	26.8	-	26.6	ns
V <sub>CC(A)</sub> =	2.3 V to 2.7 V												
t <sub>PLH</sub>	LOW to HIGH	A to B	2.0	19.7	2.0	17.6	1.3	9.4	1.1	6.9	0.9	5.3	ns
	propagation delay	B to A	1.8	14.9	1.9	10.3	1.3	9.4	1.2	8.8	0.9	8.3	ns
t <sub>PHL</sub>	HIGH to LOW	A to B	2.0	17.4	1.8	14.2	1.2	8.3	1.1	6.0	8.0	5.1	ns
	propagation delay	B to A	1.6	13.0	1.7	9.4	1.2	8.3	1.1	7.7	0.8	6.9	ns
t <sub>PHZ</sub>	HIGH to OFF-state	DIR to A	1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	ns
	propagation delay	DIR to B	2.7	24.8	2.7	23.6	2.2	12.1	2.5	10.3	2.0	7.6	ns
t <sub>PLZ</sub>	LOW to OFF-state	DIR to A	1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	ns
	propagation delay	DIR to B	2.0	16.1	2.2	14.6	1.8	9.9	2.2	9.3	1.6	6.4	ns
t <sub>PZH</sub>	OFF-state to HIGH	DIR to A [1]	-	31.0	-	24.9	-	19.3	-	18.1	-	14.7	ns
	propagation delay	DIR to B [1]	-	26.1	-	24.0	-	15.8	-	13.3	-	11.7	ns
t <sub>PZL</sub>	OFF-state to LOW	DIR to A [1]	-	37.8	-	33.0	-	20.4	-	18.0	-	14.5	ns
	propagation delay	DIR to B [1]	-	26.4	-	23.2	-	17.3	-	15.0	-	14.1	ns
$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$													
t <sub>PLH</sub>		A to B	2.0	18.9	1.8	17.1	1.2	8.8	0.7	6.2	0.6	4.9	ns
	propagation delay	B to A	1.5	13.0	1.5	8.0	1.1	6.9	0.6	6.2	0.5	6.0	ns
t <sub>PHL</sub>	HIGH to LOW	A to B	1.9	17.2	1.8	13.9	1.1	7.7	0.7	5.5	0.6	4.4	ns
	propagation delay	B to A	1.5	12.0	1.6	7.9	1.1	6.0	0.7	5.5	0.6	5.0	ns
t <sub>PHZ</sub>	HIGH to OFF-state	DIR to A	2.0	8.1	2.0	8.1	2.0	8.1	2.0	8.1	2.4	8.1	ns
	propagation delay	DIR to B	2.6	19.8	2.6	18.2	2.0	11.2	2.4	9.5	1.9	7.0	ns
t <sub>PLZ</sub>	LOW to OFF-state	DIR to A	1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	ns
	propagation delay	DIR to B	2.0	15.0	2.1	13.8	1.7	8.6	2.0	7.9	1.5	5.4	ns
t <sub>PZH</sub>	OFF-state to HIGH	DIR to A [1]	-	28.0	-	21.8	-	15.5	-	14.1	-	11.4	ns
	propagation delay	DIR to B [1]	-	25.1	-	23.3	-	15.0	-	12.4	-	11.1	ns
t <sub>PZL</sub>	OFF-state to LOW	DIR to A [1]	-	31.8	-	26.1	-	17.2	-	15.0	-	12.0	ns
	propagation delay	DIR to B [1]	-	25.3	-	22.0	-	15.8	-	13.6	-	12.5	ns
V <sub>CC(A)</sub> =	4.5 V to 5.5 V												
t <sub>PLH</sub>	LOW to HIGH	A to B	1.9	18.3	1.7	16.7	0.9	8.3	0.6	6.0	0.4	4.3	ns
	propagation delay	B to A	1.4	11.6	1.2	7.5	0.9	5.3	0.6	4.9	0.4	4.3	ns
t <sub>PHL</sub>	HIGH to LOW	A to B	2.0	16.9	1.6	13.5	0.9	6.9	0.6	5.0	0.4	3.9	ns
	propagation delay	B to A	1.5	11.9	1.5	7.7	0.8	5.1	0.6	4.4	0.4	3.9	ns
t <sub>PHZ</sub>	HIGH to OFF-state	DIR to A	1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	ns
	propagation delay	DIR to B	2.6	19.1	2.6	17.8	2.0	10.7	2.4	8.8	2.2	6.3	ns
t <sub>PLZ</sub>	LOW to OFF-state	DIR to A	1.2	4.1	1.2	4.1	1.1	4.1	0.9	4.1	0.8	4.1	ns
	propagation delay			14.5	2.1	13.4	1.7	8.2					

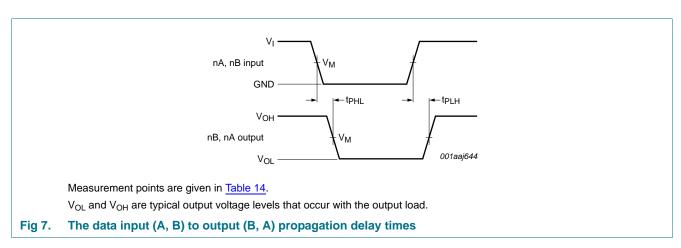
Table 13. Dynamic characteristics for temperature range –40 °C to +125 °C ...continued

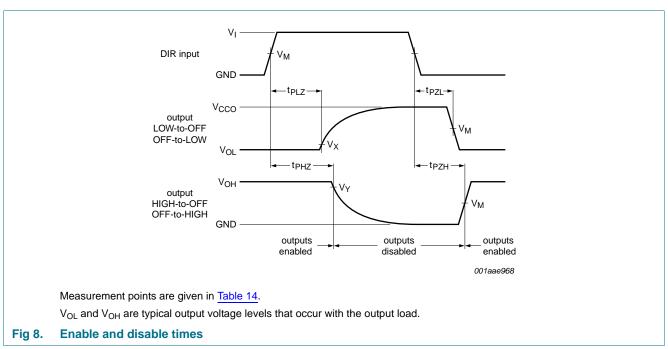
Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9; for wave forms see Figure 7 and Figure 8.

		10	,,				-			-				
Symbol	Parameter	Conditions						Vcc	(B)					Unit
			1.5	5 V ± 0.	1 V	1.8 V ±	0.15 V	2.5 V ±	0.2 V	3.3 V ±	0.3 V	5.0 V ±	0.5 V	
			M	lin M	ах	Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>PZH</sub>	OFF-state to HIGH	DIR to A	<u>1]</u> .	- 26	5.1	-	20.9	-	13.5	-	12.6	-	9.3	ns
	propagation delay	DIR to B	<u>1]</u> .	- 22	2.4	-	20.8	-	12.4	-	10.1	-	8.4	ns
t <sub>PZL</sub>	OFF-state to LOW	DIR to A	<u>1]</u> .	- 31	1.0	-	25.5	-	15.8	-	13.2	-	10.2	ns
	propagation delay	DIR to B	<u>1]</u> .	- 22	2.9	-	19.5	-	12.9	-	11.0	-	9.9	ns

<sup>[1]</sup> t<sub>PZH</sub> and t<sub>PZL</sub> are calculated values using the formula shown in Section 14.4 "Enable times".

### 12. Waveforms





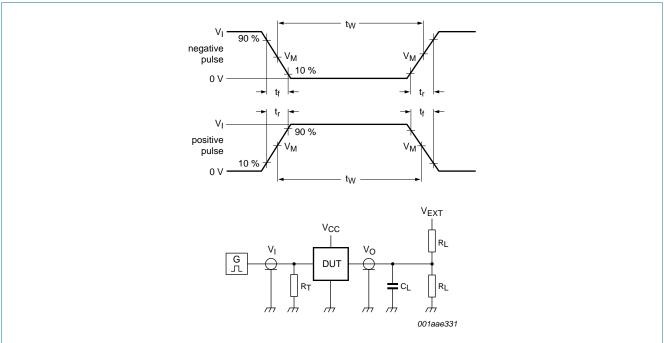
74LVC\_LVCH2T45

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Table 14. Measurement points

Supply voltage	Input <sup>[1]</sup>	Output[2]		
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
1.2 V to 1.6 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.1 V	$V_{OH}-0.1~V$
1.65 V to 2.7 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V
3.0 V to 5.5 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 V$

- [1]  $V_{CCI}$  is the supply voltage associated with the data input port.
- [2] V<sub>CCO</sub> is the supply voltage associated with the output port.



Test data is given in Table 15.

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

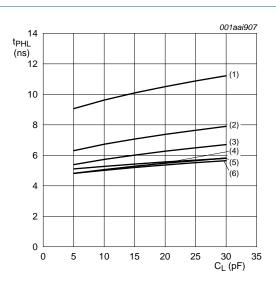
Table 15. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>				
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	V <sub>I</sub> [1]	Δt/ΔV[2]	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub> [3]		
1.2 V to 5.5 V	$V_{CCI}$	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>		

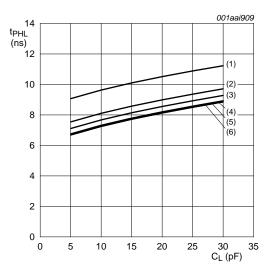
- [1]  $V_{CCI}$  is the supply voltage associated with the data input port.
- [2]  $dV/dt \ge 1.0 V/ns$ .
- [3]  $V_{CCO}$  is the supply voltage associated with the output port.

74LVC\_LVCH2T45

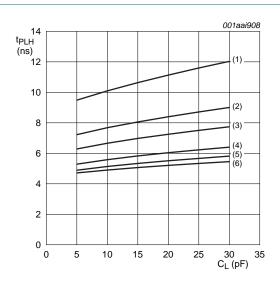
## 13. Typical propagation delay characteristics



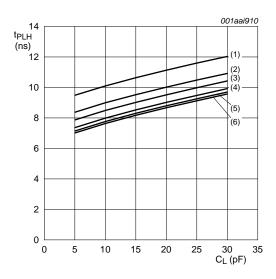
a. HIGH to LOW propagation delay (A to B)



- c. HIGH to LOW propagation delay (B to A)
- (1)  $V_{CC(B)} = 1.2 \text{ V}.$
- (2)  $V_{CC(B)} = 1.5 \text{ V}.$
- (3)  $V_{CC(B)} = 1.8 \text{ V}.$
- (4)  $V_{CC(B)} = 2.5 \text{ V}.$
- (5)  $V_{CC(B)} = 3.3 \text{ V}.$
- (6)  $V_{CC(B)} = 5.0 \text{ V}.$

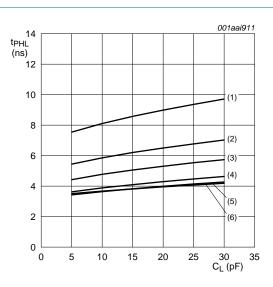


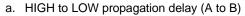
b. LOW to HIGH propagation delay (A to B)

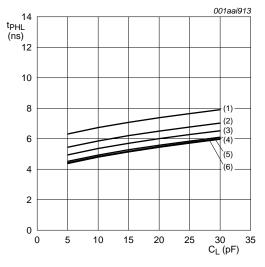


d. LOW to HIGH propagation delay (B to A)

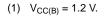
Fig 10. Typical propagation delay versus load capacitance; T<sub>amb</sub> = 25 °C; V<sub>CC(A)</sub> = 1.2 V







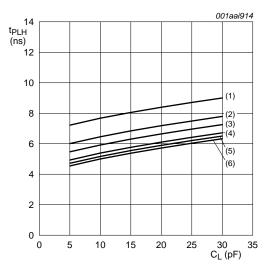
c. HIGH to LOW propagation delay (B to A)



- (2)  $V_{CC(B)} = 1.5 \text{ V}.$
- (3)  $V_{CC(B)} = 1.8 \text{ V}.$
- (4)  $V_{CC(B)} = 2.5 \text{ V}.$
- (5)  $V_{CC(B)} = 3.3 \text{ V}.$
- (6)  $V_{CC(B)} = 5.0 \text{ V}.$

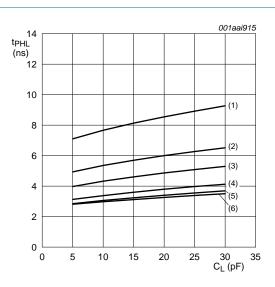
001aai912 t<sub>PLH</sub> (ns) 12 (1) 10 8 (2) (3) 6 (4) (5) 4 (6) 2 0 C<sub>L</sub> (pF)

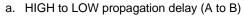
b. LOW to HIGH propagation delay (A to B)

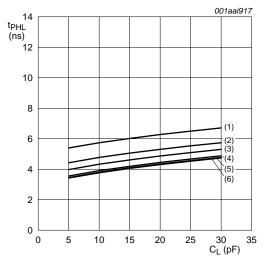


d. LOW to HIGH propagation delay (B to A)

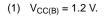






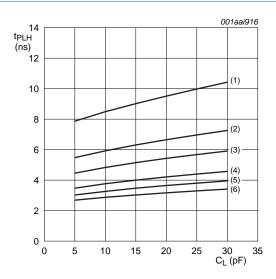


c. HIGH to LOW propagation delay (B to A)

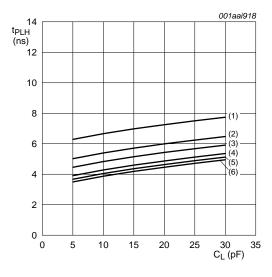


- (2)  $V_{CC(B)} = 1.5 \text{ V}.$
- (3)  $V_{CC(B)} = 1.8 \text{ V}.$
- (4)  $V_{CC(B)} = 2.5 \text{ V}.$
- (5)  $V_{CC(B)} = 3.3 \text{ V}.$
- (6)  $V_{CC(B)} = 5.0 \text{ V}.$



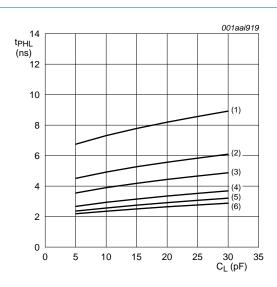


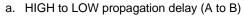
b. LOW to HIGH propagation delay (A to B)

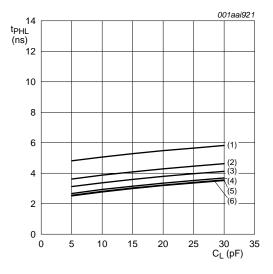


d. LOW to HIGH propagation delay (B to A)

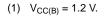






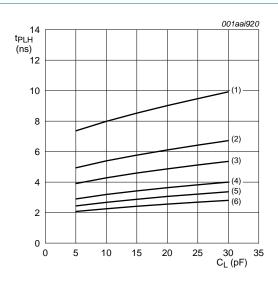


c. HIGH to LOW propagation delay (B to A)

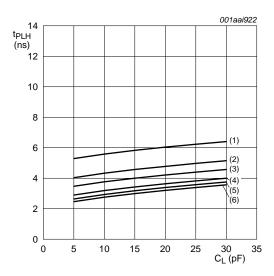


<sup>(2)</sup>  $V_{CC(B)} = 1.5 \text{ V}.$ 

(6)  $V_{CC(B)} = 5.0 \text{ V}.$ 



b. LOW to HIGH propagation delay (A to B)



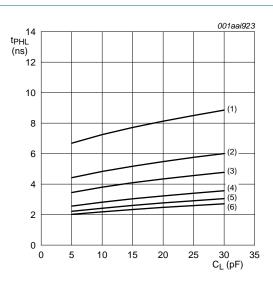
d. LOW to HIGH propagation delay (B to A)

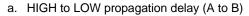
Fig 13. Typical propagation delay versus load capacitance;  $T_{amb}$  = 25 °C;  $V_{CC(A)}$  = 2.5 V

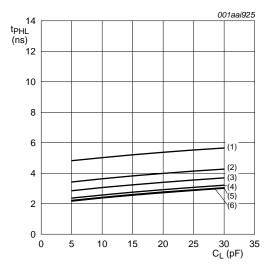
<sup>(3)</sup>  $V_{CC(B)} = 1.8 \text{ V}.$ 

<sup>(4)</sup>  $V_{CC(B)} = 2.5 \text{ V}.$ 

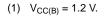
<sup>(5)</sup>  $V_{CC(B)} = 3.3 \text{ V}.$ 



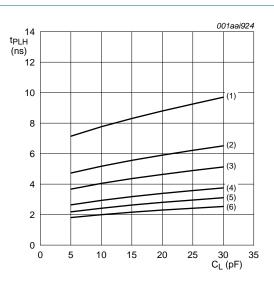




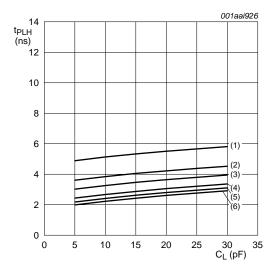
c. HIGH to LOW propagation delay (B to A)



- (2)  $V_{CC(B)} = 1.5 \text{ V}.$
- (3)  $V_{CC(B)} = 1.8 \text{ V}.$
- (4)  $V_{CC(B)} = 2.5 \text{ V}.$
- (5)  $V_{CC(B)} = 3.3 \text{ V}.$
- (6)  $V_{CC(B)} = 5.0 \text{ V}.$

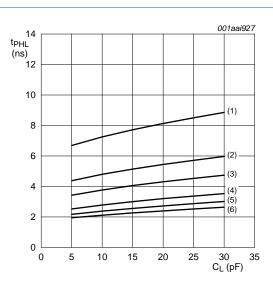


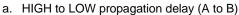
b. LOW to HIGH propagation delay (A to B)

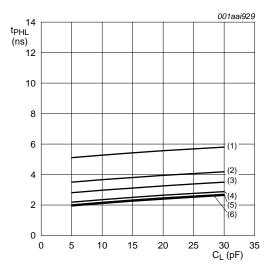


d. LOW to HIGH propagation delay (B to A)

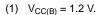






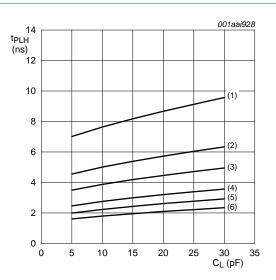


c. HIGH to LOW propagation delay (B to A)

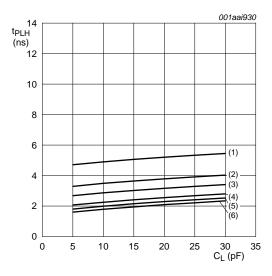


- (2)  $V_{CC(B)} = 1.5 \text{ V}.$
- (3)  $V_{CC(B)} = 1.8 \text{ V}.$
- (4)  $V_{CC(B)} = 2.5 \text{ V}.$
- (5)  $V_{CC(B)} = 3.3 \text{ V}.$
- (6)  $V_{CC(B)} = 5.0 \text{ V}.$

Fig 15. Typical propagation delay versus load capacitance;  $T_{amb} = 25 \, ^{\circ}C$ ;  $V_{CC(A)} = 5 \, V$ 



b. LOW to HIGH propagation delay (A to B)



d. LOW to HIGH propagation delay (B to A)

## 14. Application information

#### 14.1 Unidirectional logic level-shifting application

The circuit given in <u>Figure 16</u> is an example of the 74LVC2T45; 74LVCH2T45 being used in a unidirectional logic level-shifting application.

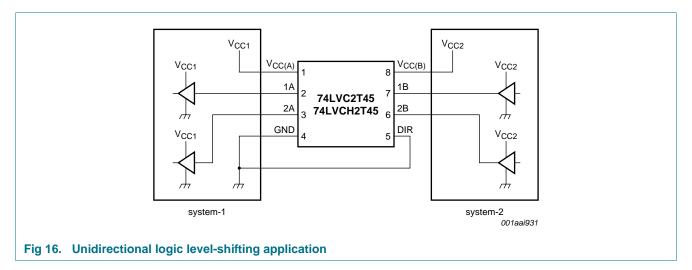
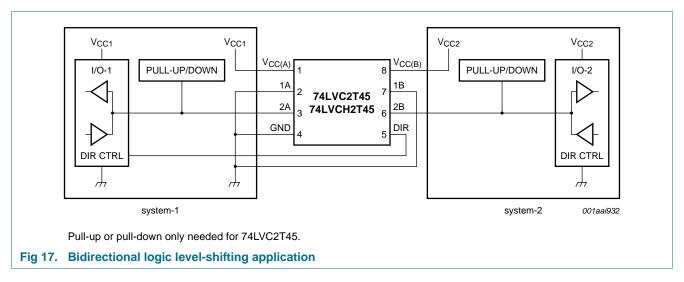


Table 16. Description of unidirectional logic level-shifting application

Pin	Name	Function	Description
1	$V_{CC(A)}$	V <sub>CC1</sub>	supply voltage of system-1 (1.2 V to 5.5 V)
2	1A	OUT	output level depends on V <sub>CC1</sub> voltage
3	2A	OUT	output level depends on V <sub>CC1</sub> voltage
4	GND	GND	device GND
5	DIR	DIR	the GND (LOW level) determines B port to A port direction
6	2B	IN	input threshold value depends on V <sub>CC2</sub> voltage
7	1B	IN	input threshold value depends on V <sub>CC2</sub> voltage
8	$V_{CC(B)}$	$V_{CC2}$	supply voltage of system-2 (1.2 V to 5.5 V)

#### 14.2 Bidirectional logic level-shifting application

Figure 17 shows the 74LVC2T45; 74LVCH2T45 being used in a bidirectional logic level-shifting application. Since the device does not have an output enable pin, the system designer should take precautions to avoid bus contention between system-1 and system-2 when changing directions.



<u>Table 17</u> gives a sequence that will illustrate data transmission from system-1 to system-2 and then from system-2 to system-1.

Table 17. Description of bidirectional logic level-shifting application[1]

State	DIR CTRL	I/O-1	I/O-2	Description
1	Н	output	input	system-1 data to system-2
2	Н	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold
3	L	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 still are disabled. The bus-line state depends on bus hold
4	L	input	output	system-2 data to system-1

<sup>[1]</sup> H = HIGH voltage level;

#### 14.3 Power-up considerations

The device is designed such that no special power-up sequence is required other than GND being applied first.

Table 18. Typical total supply current  $(I_{CC(A)} + I_{CC(B)})$ 

V <sub>CC(A)</sub>	V <sub>CC(B)</sub>	V <sub>CC(B)</sub>					
	0 V	1.8 V	2.5 V	3.3 V	5.0 V		
0 V	0	< 1	< 1	< 1	< 1	μΑ	
1.8 V	< 1	< 2	< 2	< 2	2	μΑ	
2.5 V	< 1	< 2	< 2	< 2	< 2	μΑ	
3.3 V	< 1	< 2	< 2	< 2	< 2	μΑ	
5.0 V	< 1	2	< 2	< 2	< 2	μΑ	

L = LOW voltage level;

Z = high-impedance OFF-state.

#### 14.4 Enable times

Calculate the enable times for the 74LVC2T45; 74LVCH2T45 using the following formulas:

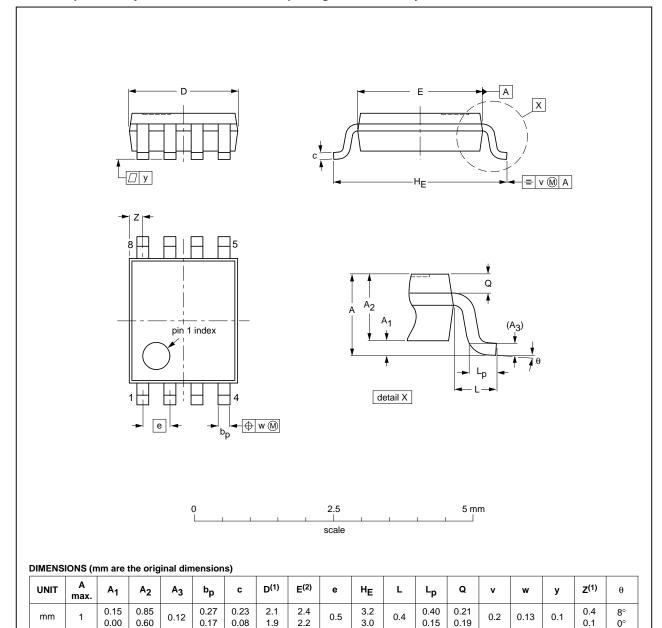
- $t_{PZH}$  (DIR to A) =  $t_{PLZ}$  (DIR to B) +  $t_{PLH}$  (B to A)
- $t_{PZL}$  (DIR to A) =  $t_{PHZ}$  (DIR to B) +  $t_{PHL}$  (B to A)
- $t_{PZH}$  (DIR to B) =  $t_{PLZ}$  (DIR to A) +  $t_{PLH}$  (A to B)
- $t_{PZL}$  (DIR to B) =  $t_{PHZ}$  (DIR to A) +  $t_{PHL}$  (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the 74LVC2T45; 74LVCH2T45 initially is transmitting from A to B, then the DIR bit is switched, the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

## 15. Package outline

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1



- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- Plastic or metal protrusions of 0.25 mm maximum per side are not included.

REFERENCES				EUROPEAN	ISSUE DATE
IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	MO-187				02-06-07
	IEC				IEC JEDEC JEITA PROJECTION

Fig 18. Package outline SOT765-1 (VSSOP8)

74LVC\_LVCH2T45

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26 of 36

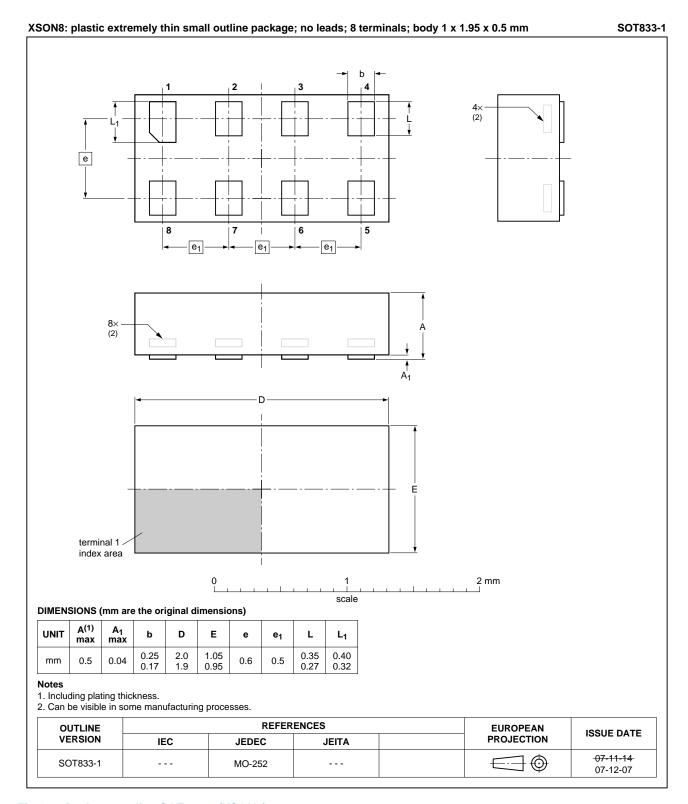


Fig 19. Package outline SOT833-1 (XSON8)

74LVC\_LVCH2T45

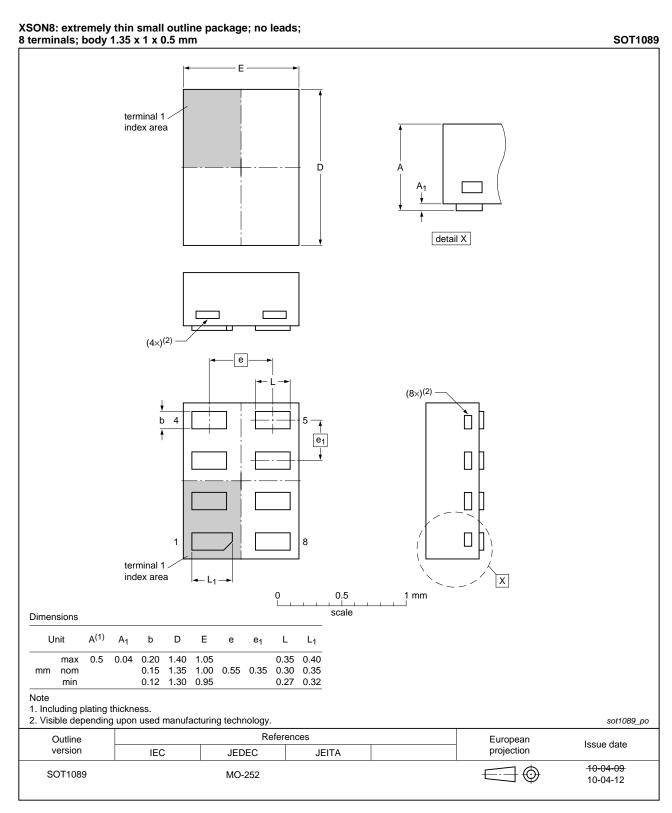


Fig 20. Package outline SOT1089 (XSON8)

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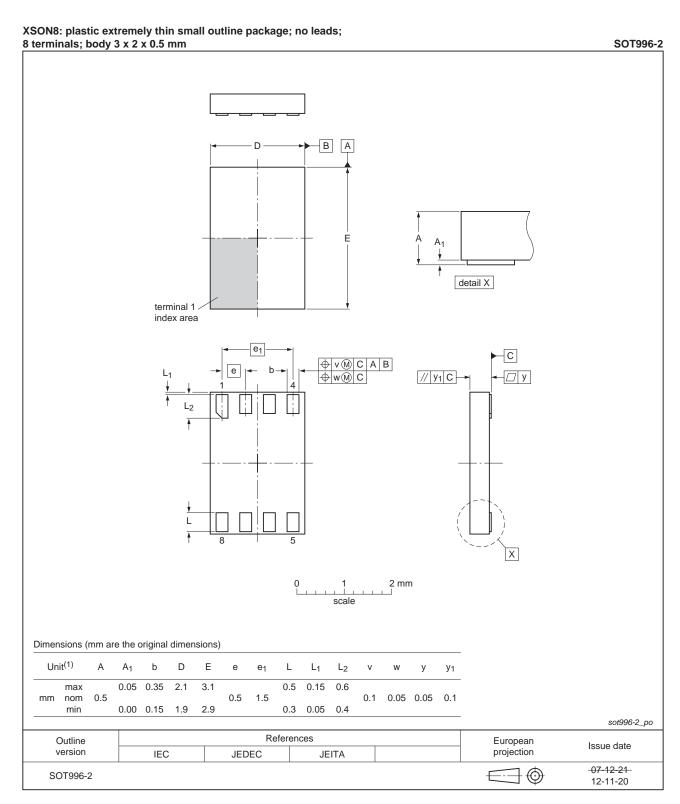


Fig 21. Package outline SOT996-2 (XSON8)

74LVC\_LVCH2T45

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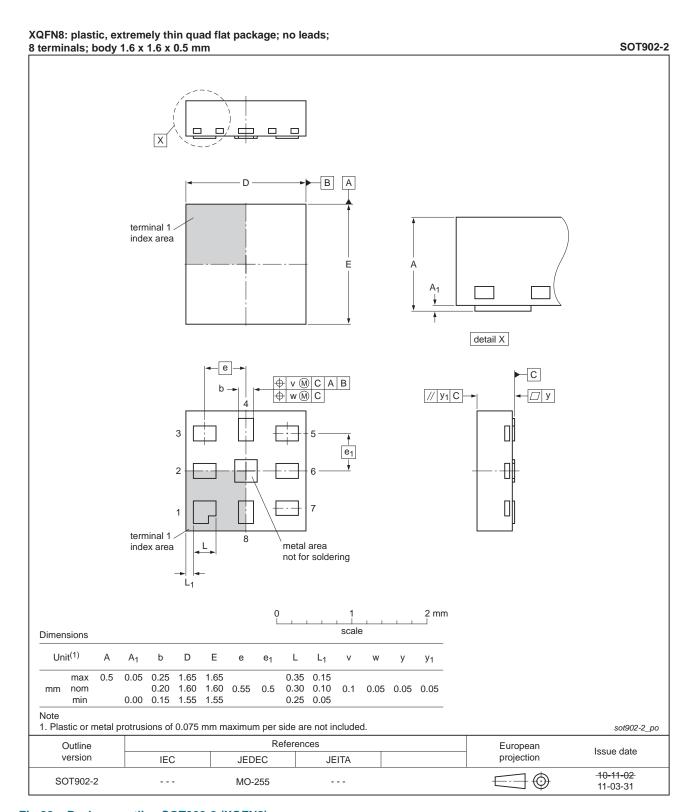


Fig 22. Package outline SOT902-2 (XQFN8)

74LVC\_LVCH2T45

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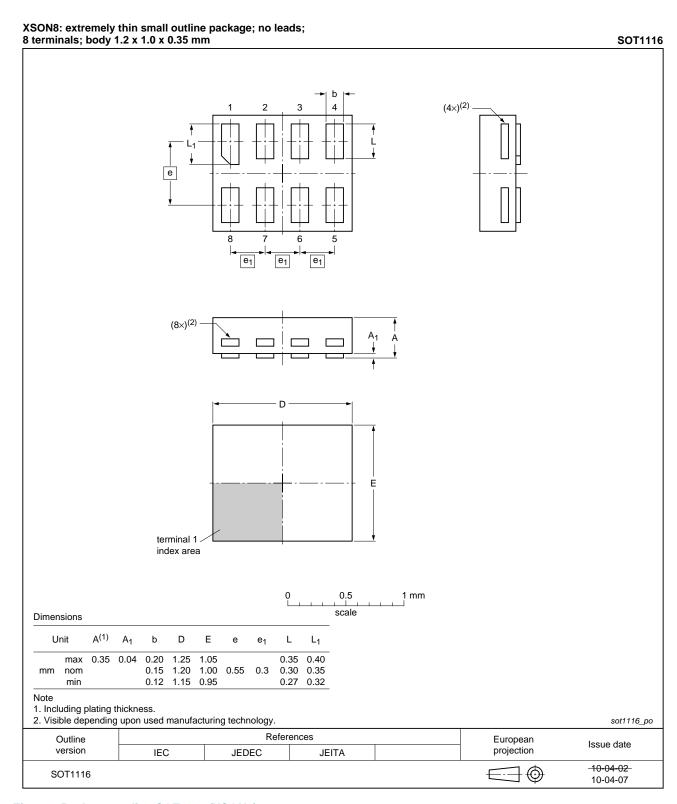


Fig 23. Package outline SOT1116 (XSON8)

74LVC\_LVCH2T45

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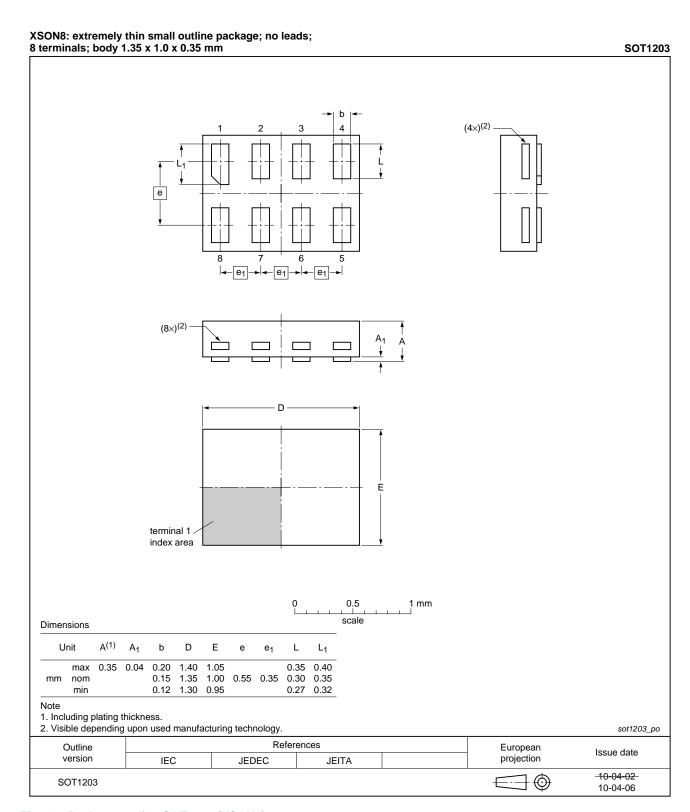


Fig 24. Package outline SOT1203 (XSON8)

74LVC\_LVCH2T45

**Product data sheet** 

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32 of 36

## 16. Abbreviations

#### Table 19. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

## 17. Revision history

#### Table 20. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH2T45 v.8	20130329	Product data sheet	-	74LVC_LVCH2T45 v.7
Modifications:	<ul> <li>For type nur</li> </ul>	mbers 74LVC2T45GD and 7	74LVCH2T45GD XSON	8U has changed to XSON8.
74LVC_LVCH2T45 v.7	20120619	Product data sheet	-	74LVC_LVCH2T45 v.6
Modifications:	<ul> <li>For type nur SOT902-2.</li> </ul>	mbers 74LVC2T45GM and	74LVCH2T45GM the S0	OT code has changed to
74LVC_LVCH2T45 v.6	20111209	Product data sheet	-	74LVC_LVCH2T45 v.5
Modifications:	<ul> <li>Legal pages</li> </ul>	s updated.		
74LVC_LVCH2T45 v.5	20110927	Product data sheet	-	74LVC_LVCH2T45 v.4
74LVC_LVCH2T45 v.4	20100820	Product data sheet	-	74LVC_LVCH2T45 v.3
74LVC_LVCH2T45 v.3	20100119	Product data sheet	-	74LVC_LVCH2T45 v.2
74LVC_LVCH2T45 v.2	20090205	Product data sheet	-	74LVC_LVCH2T45 v.1
74LVC_LVCH2T45 v.1	20081118	Product data sheet	-	-

### 18. Legal information

#### 18.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nexperia.com">http://www.nexperia.com</a>.

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## 74LVC2T45; 74LVCH2T45

#### **Dual supply translating transceiver; 3-state**

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## 74LVC2T45; 74LVCH2T45

## **Nexperia**

Dual supply translating transceiver; 3-state

## 20. Contents

1	General description	1
2	Features and benefits	1
3	Ordering information	2
4	Marking	
5	Functional diagram	3
6	Pinning information	3
6.1	Pinning	3
6.2	Pin description	
7	Functional description	4
8	Limiting values	5
9	Recommended operating conditions	5
10	Static characteristics	6
11	Dynamic characteristics	10
12	Waveforms	15
13	Typical propagation delay characteristics	17
14	Application information	23
14.1	Unidirectional logic level-shifting application .	23
14.2	Bidirectional logic level-shifting application	23
14.3	Power-up considerations	24
14.4	Enable times	25
15	Package outline	26
16	Abbreviations	33
17	Revision history	33
18	Legal information	34
18.1	Data sheet status	34
18.2	Definitions	34
18.3	Disclaimers	34
18.4	Trademarks	35
19	Contact information	35
20	Contents	36